# RENESAS

# H5N5004PL

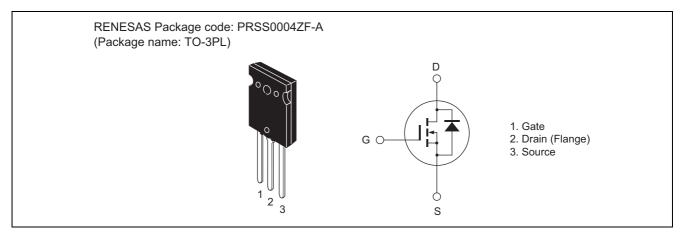
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1113-0200 (Previous: ADE-208-1381) Rev.2.00 Sep 07, 2005

### Features

- Low on-resistance:  $R_{DS (on)} = 0.09 \Omega$  typ.
- Low leakage current:  $I_{DSS} = 10 \ \mu A \ max$  (at  $V_{DS} = 500 \ V$ )
- High speed switching:  $t_f = 280$  ns typ (at  $V_{GS} = 10$  V,  $V_{DD} = 250$  V,  $I_D = 25$  A)
- Low gate charge: Qg = 220 nC typ (at  $V_{DD} = 400 \text{ V}$ ,  $V_{GS} = 10 \text{ V}$ ,  $I_D = 50 \text{ A}$ )
- Avalanche ratings
- Built-in fast recovery diode: trr = 190 ns typ

### Outline





# **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Value	Unit
Drain to source voltage	V <sub>DSS</sub>	500	V
Gate to source voltage	V <sub>GSS</sub>	±30	V
Drain current	ID	50	А
Drain peak current	ID (pulse) Note 1	200	А
Body-drain diode reverse drain current	I <sub>DR</sub>	50	А
Body-drain diode reverse drain peak current	I <sub>DR (pulse)</sub> Note 1	200	А
Avalanche current	I <sub>AP</sub> Note 3	15	А
Channel dissipation	Pch Note 2	250	W
Channel to case thermal Impedance	θ ch-c	0.5	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. Value at Tc = 25°C

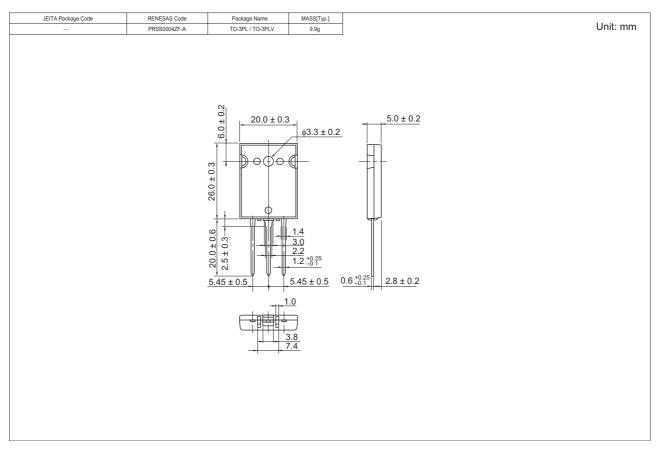
3. Tch  $\leq$  150°C

### **Electrical Characteristics**

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	500	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I <sub>GSS</sub>	—	—	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	10	μΑ	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS (off)</sub>	2.0	—	4.0	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state resistance	R <sub>DS (on)</sub>	—	0.09	0.11	Ω	$I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}^{Note 4}$
Forward transfer admittance	y <sub>fs</sub>	27	45	—	S	$I_D = 25 \text{ A}, V_{DS} = 10 \text{ V}^{Note 4}$
Input capacitance	Ciss	—	7630	—	pF	V <sub>DS</sub> = 25 V
Output capacitance	Coss	—	770	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	160		pF	f = 1 MHz
Turn-on delay time	t <sub>d (on)</sub>	—	90		ns	I <sub>D</sub> = 25 A
Rise time	tr	—	340	—	ns	V <sub>GS</sub> = 10 V
Turn-off delay time	t <sub>d (off)</sub>	—	370		ns	$R_L = 10 \Omega$
Fall time	t <sub>f</sub>	—	280		ns	Rg = 10 Ω
Total gate charge	Qg	—	220		nC	V <sub>DD</sub> = 400 V
Gate to source charge	Qgs	_	30		nC	V <sub>GS</sub> = 10 V
Gate to drain charge	Qgd	_	110		nC	I <sub>D</sub> = 50 A
Body-drain diode forward voltage	V <sub>DF</sub>	_	0.98	1.5	V	$I_F = 50 \text{ A}, V_{GS} = 0$
Body-drain diode reverse recovery time	t <sub>rr</sub>	—	190	—	ns	$I_F = 50 \text{ A}, V_{GS} = 0$
Body-drain diode reverse recovery charge	Qrr	—	1.3	_	μC	di <sub>F</sub> /dt = 100 A/µs

Note: 4. Pulse test

## **Package Dimensions**



## **Ordering Information**

Part Name	Quantity	Shipping Container
H5N5004PL-E	500 pcs	Box (Case)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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